IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Examiner: Tuan T Dinh Group Art No.: 2841 Iled: February 24, 2004

Examiner: Tuan T Dinh Group Art No.: 2841 Confirmation No.: 2942

For: CONDUCTORS CREATED BY METAL DEPOSITION USING A SELECTIVE

PASSIVATION LAYER AND RELATED METHODS

April 17, 2006

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

INFORMATION DISCLOSURE STATEMENT PURSUANT TO 37 C.F.R. § 1.97(b)

Sir:

Attached is a list of documents on Form PTO-1449, together with a copy of any listed foreign patent document and/or non-patent literature. A copy of any listed U.S. patent and/or U.S. patent application publication is not provided herewith in accordance with the amendment by the U.S. Patent and Trademark Office to 37 C.F.R. § 1.98(a)(2)(ii) effective October 21, 2004. It is requested that these documents be considered by the Examiner and officially made of record in accordance with the provisions of 37 C.F.R. §1.56 and Section 609 of the MPEP.

This Information Disclosure Statement is submitted in accordance with 37 C.F.R. § 1.97(b), within three months of the filing date of the above-referenced application or before the mailing of a first Office Action on the merits, whichever event occurs last. Therefore, no fee is believed due. However, the Commissioner is hereby authorized to charge any deficiency or credit any overpayment to Deposit Account No. 50-0220.

Respectfully submitted

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8usan E. Freedman

Date of Signature: April 17, 2006

Substitute	e form 1449A/PTO	
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Sheet	1 of 2	12 20/
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C	omplete if Known	
Application Number	10/785,615	
Filing Date	02/24/2004	
First Named Inventor	Jeffry A. Kelber	
Group Art Unit	2841	
Examiner Name	Tuan T. Dinh	
Attorney Docket Number	5347-223	

		OTHER NON PATENT LITERATURE DOCUMENTS	
Examiner nitials*	Cite No.	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published	Т
	1.	Bertel et al "The Adsorption of Bromine on Pt(111): Observation of an Irreversible Order-Disorder Transition" Surface Science 83:439-452 (1979)	
	2.	Bhaskar et al. "X-ray photoelectron spectroscopy and micro-Raman analysis of conductive RuO ₂ Thin Films" <u>Journal of Applied Physics</u> , 89(5):2987-2992	
	3.	Böttcher et al. "Formation of subsurface oxygen at Ru(0001)" The Journal of Chemical Physics 110(6):3186-3195 (1999)	
	4.	Chan et al. "High-Pressure Oxidation of Ruthenium as Probed by Surface-Enhanced Raman and X-Ray Photoelectron Spectroscopies" <u>Journal of Catalysis</u> 172:336-345 (1997)	
	5.	Chyan et al. "Electrodeposition of Copper Thin Film on Ruthenium A Potential Diffusion Barrier for Cu Interconnects" <u>Journal of the Electrochemical Society</u> 150(5):C347-C350 (2003)	
	6.	Cumpson et al. "Elastic Scattering Corrections in AES and XPS. II. Estimating Attenuation Lengths and Conditions Required for their Valid Use in Overlayer/Substrate Experiments" <u>Surface and Interface Analysis</u> 25:430-446 (1997)	
	7.	DiCenzo et al. "XPS Studies of Adatom-Adatom Interactions: I/Ag(111) and I/Cu(111) Surface Science 121:411-420 (1982)	
	8.	Feibelman "Partial Dissociation of Water on Ru(0001)" Science 295(5552):99-102 (2002)	
	9.	Garwood, Jr. et al. "Surperlattices Formed by Interaction of Iodine, Water and Oxygen With the (111)	
		Plane of an Fe-Cr-Ni Alloy fcc Single Crystal: Studies by Leed, Auger and Thermal Desorption Mass Spectroscopy" Surface Science 121:L524-L530 (1982)	
	10.	Grant et al. "A Study of Ru(0001) and Rh(111) Surfaces Using Leed and Auger Electron Spectroscopy" Surface Science 21:76-85 (1970)	
	11.	Hubbard "Electrochemistry at Well-Characterized Surfaces" Chem. Rev 88:633-656 (1988)	
	12.	Hwang et al. "Surfactant-Assisted Metallorganic CVD of (111)-Oriented Copper Films with Excellent Surface Smoothness" <u>Electrochemical and Solid-State Letters</u> 3(3):138-140 (2000)	
	13.	Kibler et al. "Initial stages of Pd deposition on Au(hkl) Part I: Pd on Au(111)" <u>Surface Science</u> 443:19-30 (1999)	
	14.	Kim et al. "Chemical state of ruthenium submonolayers on a Pt(111) electrode" Surface Science 474:L203-L212 (2001)	
	15.	Kiskinova et al. "Adsorption and Decomposition of H ₂ O on a K-Covered Pt(111) Surface" Surface Science, 150:319-338 (1985)	
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	18.	Lin et al. "Combined Ultrahigh Vacuum/Electrochemistry Study of the Adsorption of Lead on Clean and Sulfur-Modified Nickel Surfaces in Aqueous Environments" <u>Langmuir</u> 14:3673-3681 (1998)	
	19.	Liu et al. "The Effects of an Iodine Surface Layer on Ru Reactivity in Air and during Cu Electrodeposition" J. Electrochem. Soc, 152(2):G115-G121 (2005)	
	20.	Lu et al. "Adlattice Structure and Hydrophobicity of Pt(111) In Aqueous Potassium Iodide Solutions Influence of pH and Electrode Potential" J. Electroanal. Chem. 222:305-320 (1987)	
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	22.	Madey et al. "Adsorption of Oxygen and Oxidation of CO on the Ruthenium (001) Surface Science 48:304-328 (1975)	
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	25. Nakamura et al. "Monomer and tetramer water clusters adsorbed on Ru(0001)" Chemical Physics Letters 325:293-298 (2000)		
	26.	Oskam et al. "Electrochemical Deposition of Copper on n-Si/TiN" <u>Journal of the Electrochemical</u> <u>Society</u> 146(4):1436-1441 (1999)	
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	28.	Reuter et al. "Atomistic description of oxide formation on metal surfaces: the example of ruthenium" Chemical Physics Letters 352:311-317 (2002)	
Examiner S	ignature		
	J	Date considered	

*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

Substitute form 1449A/PTO		Complete if Known		
		Application Number	10/785,615	
INFOR	MATION DISCLOSURE	Filing Date	02/24/2004	
STATEMENT BY APPLICANT (use as many sheets as necessary)		First Named Inventor	Jeffry A. Kelber	
		Group Art Unit	2841	
		Examiner Name	Tuan T. Dinh	
Sheet	2 of 2	Attorney Docket Number	5347-223	

		OTHER NON PATENT LITERATURE DOCUMENTS	
Examiner Initials*	Cite No.	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published	Т
	29.	Seshadri et al. "Sulfur Catalyzed Electrochemical Oxidation of Copper: A Combined Ultrahigh Vacuum Electrochemistry Study" Journal of the Electrochemical Society 146(5):1762-1765 (1999)	
	30.	Seshadri et al. "The Promotion of the Anodic Dissolution of Polycrystalline Iron Surfaces by Adsorbed Sulfur: A UHV-Electrochemical Study" Corrosion Science 39(5):987-1000 (1997)	
	31.	Shen et al. "An ESCA study of the interaction of oxygen with the surface of ruthenium" Applied Surface Science 51:47-60 (1991)	
	32.	Sherwood "Curve fitting in surface analysis and the effect of background inclusion in the fitting process" J. Vac. Sci. Technol A 14(3):1424-1432	
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	39.	Tanaka et al. "Kinetics of Oxidization Processes of Ruthenium Particles" <u>J. Am. Ceram. Soc.</u> 81(10):2513-2516 (1998)	
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Examiner Signature		Date Considered	
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